1.SCOPE

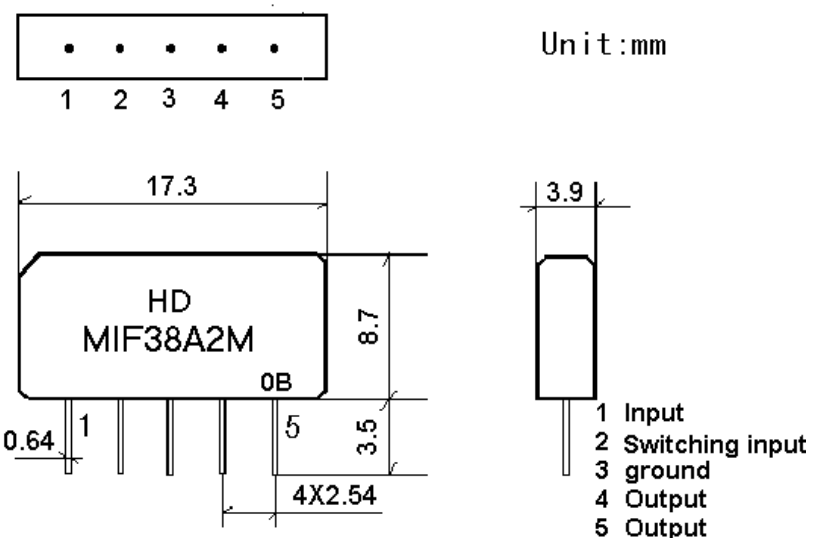
HAODA's SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. they are used in electronic equipments such as TV and so on.

2.Construction

2.1 Dimension and materials

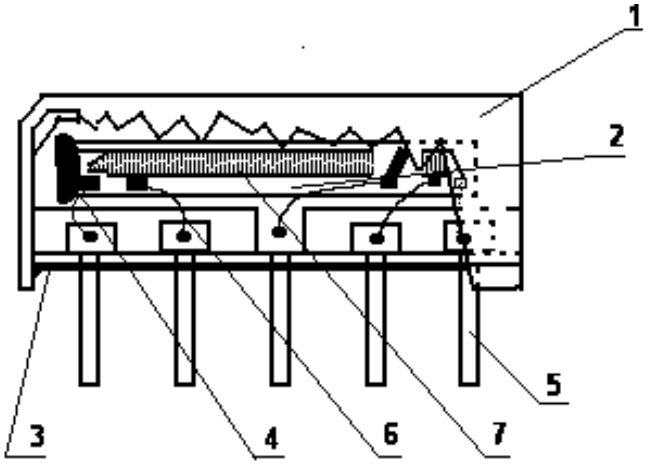
Manufacturer's name : HAODA ELECTRONICS Co. LTD(CHINA)

Type : MIF38A2M



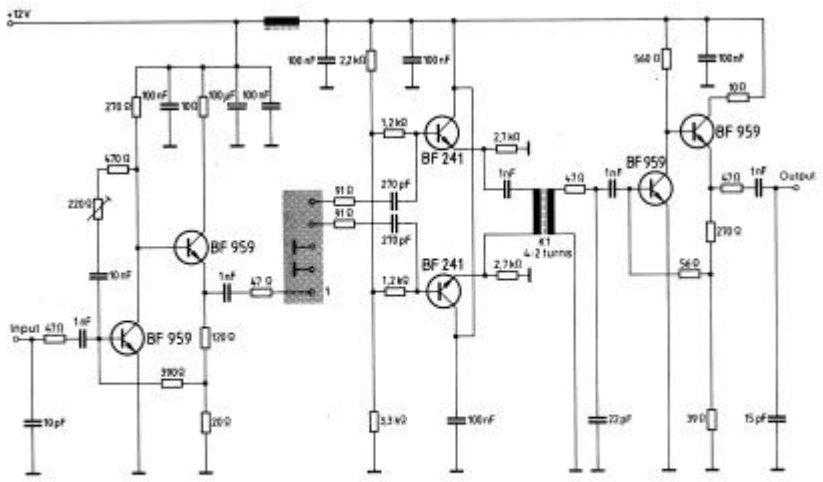
0: year(0,1,2,3,4,5,6,7,8,9)

B:product in this quarter(A:1~3,B:4~6,C:7~9,D:10~12)



Components	Materials
1.Outer casing	PPS
2.Substrate	Lithium niobate
3.Base	Epoxy resin
4.Absorber	Epoxy resin
5.Lead	Cu alloy+Au plate
6.Bonding wire	AlSi alloy
7.Electrode	Al

2.2. Circuit construction, measurement circuit



Test circuit for SIP-5 filter
Input impedance of the symmetrical post-amplifier: 2 kΩ in parallel with 3 pF

3.Characteristics

Standard atmospheric conditions

Unless otherwise specified , the standard rang of atmospheric conditions for making measurements and tests is as follows;

Ambient temperature : 15℃ to 35℃
Relative humidity : 25% to 85%
Air pressure : 86kPa to 106kPa

Operating temperature rang

Operating temperature rang is the rang of ambient temperatures in which the filter can be
operated continuously. -10℃ ~ +60℃

Storage temperature rang

Storage temperature rang is the rang of ambient temperatures at which the filter can be stored
without damage.
Conditions are as specified elsewhere in these specifications. -40℃ ~ +70℃

Reference temperature +25℃

3.1 Maximum Rating

DC voltage VDC	**12**	**V**	**Between any terminals**
AC voltage Vpp	**10**	**V**	**Between any terminals**

3.2 Electrical Characteristics

Characteristics in B/G,D/K mode (switching input pin 2 connected to ground pin 3)

Source impedance Zs=50Ω

Load impedance Z_L=2kΩ//3pF T_A=25℃

Item		Freq	min	typ	max	
Insertion attenuation Reference level		36.50MHz	15.7	17.7	19.7	dB
Relative attenuation		38.00MHz	4.5	6.0	7.5	dB
		33.57MHz	-0.1	1.4	2.9	dB
		31.50MHz	42.0	60.0	-	dB
		32.50MHz	32.0	45.0	-	dB
		30.00MHz	41.0	52.0	-	dB
		31.00MHz	42.0	54.0	-	dB
		39.50MHz	41.0	51.0	-	dB
Sidelobe	25.00~30.00MHz		38.0	45.0		dB
	39.50~45.00MHz		34.0	39.0		dB
Reflected wave signal suppression 1.3 us …6.0 us after main pulse (test pulse 250 ns , carrier frequency 36.50 MHz)			40.0	50.0		dB
Feedthrough signal suppression 1.2 us …6.0 us after main pulse (test pulse 250 ns , carrier frequency 36.50 MHz)			42.0	52.0		dB
Temperature coefficient			-72			ppm/k

Characteristics in M/N mode (switching input pin 2 connected to input pin 1)

Source impedance Zs=50Ω

Load impedance Z_L=2kΩ//3pF T_A=25℃

Item		Freq	min	Typ	max	
Insertion attenuation Reference level		36.50MHz	14.0	16.0	18.0	dB
Relative attenuation		38.00MHz	4.7	6.2	7.7	dB
		34.42MHz	2.3	3.8	5.3	dB
		33.50MHz	18.3	20.3	22.3	dB
		32.00MHz	40.0	48.0	-	dB
		39.50MHz	40.0	53.0	-	dB
Sidelobe	25.00~32.00MHz		36.0	45.0		dB
	39.50~45.00MHz		35.0	41.0		dB
Reflected wave signal suppression 1.3 us …6.0 us after main pulse (test pulse 250 ns , carrier frequency 36.50 MHz)			40.0	50.0		dB

Feedthrough signal suppression 1.2 us …6.0 us after main pulse (test pulse 250 ns , carrier frequency 36.50 MHz)	42.0	48.0		dB
Temperature coefficient	-72			ppm/k

3.3 Environmental Performance Characteristics

Item Test condition	Allowable change of absolute Level at center frequency(dB)
High temperature test 70℃ 1000H	< 1.0
Low temperature test -40℃ 1000H	< 1.0
Humidity test 40℃ 90-95% 1000H	< 1.0
Thermal shock -20℃==25℃==80℃ 20 cycle 30M 10M 30M	< 1.0
Solder temperature test Sold temp.260℃ for 10 sec.	< 1.0
Soldering Immerse the pins melt solder at 260℃+5/-0℃ for 5 sec.	More then 95% of total area of the pins should be covered with solder

3.4 Mechanical Test

Item Test condition	Allowable change of absolute Level at center frequency(dB)
Vibration test 600-3300rpm amplitude 1.5mm 3 directions 2 H each	<1.0
Drop test On maple plate from 1 m high 3 times	<1.0
Lead pull test Pull with 1 kg force for 30 seconds	<1.0
Lead bend test 90^{o} bending with 500g weigh 2 times	<1.0